ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® International and Part	C, Bannockl	burn, Illinois. A	Il rights reserved nations.	under both	This docume level parts, t	ent is a declara	tion of the s encompasse	substances es all lowe	within the n r level mater	nanufacture rials for wh	er listed iter hich the mar	n. Note: nufacture	if the item is an as er has engineering	ssembly with low responsibility.
	IPC Web Site for Information on IPC-1752 Standard Form Ty http://www.ipc.org/IPC-175x Distribution				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater				ous Materia	als and Mfg Information				
Supplier Information														
Company name* Con			Company unique ID			Unique ID Authority					Response Date*			
onsemi								2025-06-02			2			
ontact Name Title - Contact			et	Phone - Co			contact*			Email - Contact*				
Product-Env-Stewards Product			roduct Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Repres			esentative			Phone - Representative*				Email - Representative*				
Product-Env-Stewards Pr			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Requester Item Number	Requester Item Number Mfr Item		n Number Mfr Item Name			Effective Da	e Version		Manufacturing Site		W	eight*	UOM	Unit Type
	NSVDT G	NSVDTA114YM3T5 SS SOT-723 BIA G		S RESISTOR		2025-06-02			CN1		1.2	275	mg	Each
Aanufacturing Proccess Informat	ion													
Terminal Plating / Grid Array Ma	erial Terminal Base Alloy		Alloy	J-STD-020 MSI	-020 MSL Rating		Peak Process Body Temperature Max Time at		ne at Peak	ak Temperature Number of Reflow Cycles		cles		
Matte Tin (Sn) - annealed CU Alloy		CU Alloy		1		260		C	30		seconds	3		
omments														
vel 1 - maximum time at peak temperatu	re during so	Idering is 10-3	0 seconds											
or more information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybro	ominated Biphenyls (PBB), Polybron	dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-eth						
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.										
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless otherwise noted).									
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Die	0.13	mg	Supplier	Silicon (Si)	7440-21-3		0.13	mg	
Lead Frame	0.28	mg	Supplier	Silver (Ag)	7440-22-4		0.0255	mg	
			В	Nickel (Ni)	7440-02-0		0.103	mg	
			Supplier	Iron (Fe)	7439-89-6		0.1414	mg	
			Supplier	Copper (Cu)	7440-50-8		0.0101	mg	
Mold Compound-Black	0.86	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.086	mg	
			Supplier	Carbon Black (C)	1333-86-4		0.0043	mg	
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.1247	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		0.559	mg	
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.086	mg	
Plating	0.003	mg	Supplier	Tin (Sn)	7440-31-5		0.003	mg	
Wire Bond - Cu	0.002	mg	Supplier	Copper (Cu)	7440-50-8		0.002	mg	